

Possible application of HTS tapes for superconducting insertion devices

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Outline



- Motivation
- R&D activities on SCIDs @ ANKA
- HTS applications to SCIDs:
 HTS tape planar undulator
 HTS tape stacked undulator
- Conclusions



Motivation R&D SCIDs



Superconducting insertion devices (IDs) can reach, for the same gap and period length, higher fields with respect to permanent magnet IDs

allowing to increase the spectral range and the brilliance when applied in low emittance storage rings, FELs, ERLs



allowing for more efficient reduction of beam emittance when employed as damping wigglers.

	IVU ¹	CPMU ²	SCU NbTi	SCU APCW ³ ,
λ_u [mm]	19	17.7	15	15
N	105	112	133	133
<i>m. gap</i> [mm]	5	5.2	6	6
<i>B</i> [T]	0.86	1.04	1.2	1.46
K	1.53	1.72	1.7	2.05



¹ F. Bødker et al., EPAC 2006 ² C.W. Ostenfeld and M. Pedersen, **IPAC 2010** ³ T. Holubek et al., Physics Procedia ⁴ http://www.supramagnetics.com/



R&D on SCIDs in Karlsruhe and at ANKA

- Work on a superconductive micro-undulator started in Karlsruhe in the early 90's Moser, H. O., Krevet, B. & Holzapfel, H. (1991), Mikroundulator, Patentschrift DE 4101094 C1, Kernforschungszentrum Karlsruhe GmbH, Germany.
- Test with beam at the MAINZ MICROTRON MAMI T. Hezel et al., PAC1999
- Device developed in collaboration with ACCEL installed at ANKA in 2005
 S. Casalbuoni, M. Hagelstein, B. Kostka, R. Rossmanith, M. Weisser, E. Steffens, A. Bernhard, D. Wollmann, and T. Baumbach Phys. Rev. ST Accel. Beams 9, 010702 (2006)
- Collaboration of ANKA with Babcock Noell GmbH (BNG) to develop two planar devices, one with switchable period length.

First experimental demonstration of period length switching for scIDs

First step: DemoSCU15 Installation in ANKA foreseen in 2012

A. Grau et al., IEEE Trans. on Appl. Supercond. 1596-1599 Vol. 21-3 (2011)













Karlsruhe Institute of Technology

R&D on SCIDs at ANKA



Tools and instruments for magnetic field characterization





restrictions with encoder Active Acti



CASPER II

A. Grau et al., IEEE Trans. on Appl. Supercond. 2312-2315 Vol. 21-3 (2011)

E. Mashkina et al., EPAC2008

and for beam heat load measurements







Delivered to Diamond light source Preliminary data

7 → PRWH (RRR 10): 0.18W → PRWH (RRR 200): 0.18W → PRWH (RRR 200): 0.10W → PRWH (RRR 200): 0.10W → S. Gerstl et al., IPAC2012 0 25 50 75 100 125 150 175 200 225 250 275 Beam Current [mA]

HTS tape application to SCIDs



- The <u>engineering current density of commercial HTS</u> materials is <u>rapidly increasing</u> in performance making them more and more attractive, so that they could be competitive with NbTi.
- High mechanical accuracy required for SC undulators in light sources exclude application of Nb3Sn coils with actual technology, that requires heat treatment after winding
- HTS tapes can be operated at higher temperatures than NbTi allowing to <u>sustain higher beam</u> <u>heat loads</u>, and therefore simplifying the cryostat design for the final device.
- Two concepts of application of HTS tapes to produce a sinusoidal field have been so far proposed:

HTS tape stacked undulator



S. Prestemon et al., IEEE Trans. on Appl. Supercond. 1880-1883 Vol. 21-3 (2011)

HTS tape planar undulator





HTS tape planar undulator: Test at CASPER I





IDMAX2010- Insertion Device Workshop 10.11.2010 - C. B



HTS tape planar undulator: Working program



- **1.** Design short mockup
- **2.** Test at CASPER I: quench + local field measurements
- **3.** Test at CASPER II: quench + local and integral field measurements
- 4. Design longer mockup
- **5.** Test at CASPER I: quench + local field measurements
- 6. Test at CASPER II: quench +local and integral field measurements

S. H. Kim et al, IEEE Trans. Appl. Supercond. 1709-1712 Vol. 21-3 (2011)

Open issues:

- Joints resistance
- Quench detection and protection
- Test field accuracy

Possible improvements:

- Reduce insulation thickness
- Increase tape current density
- Alternative design without joints





HTS tape stacked undulator: Motivation





Jare 4: Performance comparison be omising hybrid, superconducting bi-filar he¹: promising HTS tape concept technologie arth assumed for the calculation commercial product particulation by eliminating is period to by eliminating is period valia concept short period hybrid, superconducting bi-filar he¹⁷ propries hybrid, superconduction be calculated by eliminating is propries hybrid. The readily obtained by eliminating is propries hybrid. Calculations for superconductions for superconductions for the bifilar helical SCU data assumes the propries hybrid devices assume remained by eliminating is propries hybrid. Superconductions for superconductions for the bifilar helical SCU data assumes the propries hybrid devices assume remained by eliminating is propries hybrid. Superconductions for superconductions for superconductions for the bifilar helical SCU data assumes the propries hybrid devices assume remained by eliminating is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propried by the bifilar helical SCU data assumes is propr

Open issues – challenges:

- Developing a highly accurate process for making the cuts in the YBCO tape (lithography, laser cutting)
- Providing thin, uniform **insulation** of the conductors from each other and from the support structure
- Joint fabrication reproducibility, minimizing resistance, and maintaining thickness compatible with insulation
- Providing series connection from the top section to the bottom section without interrupting the beam path
- Minimizing variations in "height" along the beam path
- Develop support structure to maintain a precise beam aperture
- Quench detection and protection
- Radiation damage
- Engineering current density as a function of the magnetic field, geometry, stress
- Mechanical design



S. Prestemon et al., PAC09



HTS tape stacked undulator: Working program



KIT internal collaboration: ANKA with ITeP (W. Goldacker, R. Nast)

- **1.** Choice design parameters (period length, width of cuts, length of cuts) by Radia simulations
- **2.** Production of 1 tape machined with the design geometry by laser ITeP
- **3.** Construction of Hall probe sledge and support structure for above tape.
- **4.** Test at CASPER I: quench + field measurements
- 5. Stack two tapes
- 6. Quench test at CASPER I
- 7. Production of second tape machined with the design geometry by laser
- 8. Stack two machined tapes
- **9.** Test at CASPER I: quench + field measurements
- **10.** Production of 30 tapes machined with the design geometry by laser
- **11.** Stack machined tapes
- **12.** Test at CASPER I: quench + field measurements
- **13.** Production of other 30 tapes machined with the design geometry by laser
- **14.** Stack machined tapes
- **15.** Design and production of support structure for both stacked structure with gap to be decided (=~3mm)
- **16.** Design and production of sledge to hold Hall probes
- **17.** Test at CASPER I: quench + field measurements



HTS tape stacked undulator: Laser structuring



KIT internal collaboration: ANKA with ITeP (W. Goldacker, R. Nast)

- Etching using Trumpf picosec YAG IR laser
- Programmable beam control used already for Roebel cables
- High positioning precision
- Laser grooving is very reliable: No contamination of groove detected (SEM)
- Fast process: structuring is performed at ambient atmosphere





HTS tape stacked undulator: Setup at CASPER I







HTS tape stacked undulator: Test of single tape



Measured critical current corresponds to 1/3 of the critical current of unstructured tape (2 kA)

This test proves that laser structuring has no negative impact on superconductive properties of the tape



T. Holubek et al, to be presented at ASC 2012

First magnetic field line scans were obtained
 2.05 mm above the meander structured, 12
 mm wide HTS tape for different currents

(width of SC channel = 4 mm and period length = 8.05 mm)



Conclusions on HTS stacked undulator



Critical current measurement confirmed that laser structuring has no negative impact on superconductive properties of the tape

We obtained first magnetic field line scans above meander structured HTS tape

